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April 1st, 2010 Renesas Electronics Corporation

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Renesas Technology Corp. Customer Support Dept. April 1, 2003





M16C/80 Series

Transferring strings

1.0 Abstract

This program transfers memory contents(string data) from one location to another by using a string transfer instruction (SMOVU).

2.0 Introduction

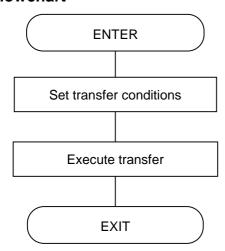
This program transfers memory contents(string data) from one location to another by using a string transfer instruction (SMOVU).

The program sets the source's start address in A0, and the destinations's start address in A1 before executing the SMOVU instruction.

Subroutine name :	ROM capacity : 10byte	
Interrupt during execution: Accepted	Number of stacks used : None	

Register/memory	Input	Output	Usage condition
R0	-	-	Unused
R1	-	-	Unused
R2	-	-	Unused
R3	-	-	Unused
A0	-	Indeterminate	Source address
A1	-	Indeterminate	Destination address
STRING1	Content of STRING1	Does not change	←
STRING2	Content of STRING2	Content of STRING1	←
Usage precautions			

3.0 Flowchart





```
4.0 Programming Code
      M16C Program Collection
      CPU: M16C/80 series
  *********************
          .EQU
VramTOP
                      0000400H
                                              ; Declares start address of RAM
VromTOP
             .EQU
                      0FE0000H
                                              ; Declares start address of ROM
      .SECTIONRAM,DATA
      .ORGVramTOP
                                              ; RAM area
LENGTH
                      16
                                             ; Length of area
             .EQU
                                              ; Source area of string transfer
STRING1:
              .BLKB
                      LENGTH
                                              ; Destination area of string transfer
STRING2:
             .BLKB
                     LENGTH
   Title: Transferring strings
   Outline: Example for using string transfer instruction
              ----->
                                              Output:
                                        R0(Unused)
   R0()
   R1()
                                        R1(Unused)
                                        R2(Unused)
   R2()
                                        R3(Unused)
   R3()
                                        A0(Indeterminate)
   A0()
   A1()
                                        A1(Indeterminate)
   Stack amount used: None
   Notes:
              .SECTION
                              PROGRAM,CODE
                              VromTOP
              .ORG
                                                      ; ROM area
                                                      ; Sets source address
  MOV.L
              #STRING1,A0
                                                      ; Sets destination address
  MOV.L
              #STRING2,A1
  SMOVU.B
                                                      ; Executes transfer of strings
```

MAEC-MCU-M16C-42-0207-R1.0

.END;



5.0 Reference

MCU Technical Information Homepage

http://www.infomicom.maec.co.jp/indexe.htm

(or http://www.mdece.com/ , http://www.mitsubishichips.com/products/mcu/index.html or your local Web Site.)

Technical Support

E-mail: support@apl.maec.co.jp

(or your local support E-mail address. A private e-mail address should NOT be used.)

Data Sheet

M16C/80 group

(Use the latest version on the Homepage: http://www.infomicom.maec.co.jp/indexe.htm)

User's Manual

M16C/80 group

(Use the latest version on the Homepage: http://www.infomicom.maec.co.jp/indexe.htm)



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